

**60V N-Channel MOSFET**

**Description**

The PM60N02M uses advanced Trench technology and designs to provide excellent  $R_{DS(ON)}$  with low gate charge. This device is suitable for use in PWM, load switching and general purpose applications.

**Features**

- High density cell design for Low  $R_{DS(on)}$
- Voltage controlled small signal switch
- Rugged and reliable
- High saturation current capability
- ESD protected Gate HBM 1KV

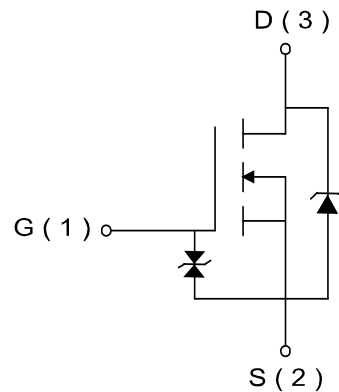
**Applications**

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

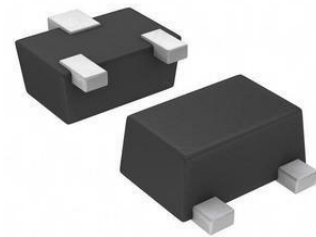
**MOSFET Product Summary**

$V_{DS}$	$R_{DS(ON)}$ @ $V_{GS}=10V$	$V_{GS(th)}$	$I_D$
60V	4.5Ω	1.2V~1.5V	0.18A

**Dimensions and Pin Configuration**



**Circuit diagram**



**SOT-723**

**Absolute Maximum Ratings ( $T_A=25^{\circ}C$  unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	±20	V
Continuous Drain Current	$I_D$	0.18	A
Power Dissipation	$P_D$	0.15	W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55~ +150	°C

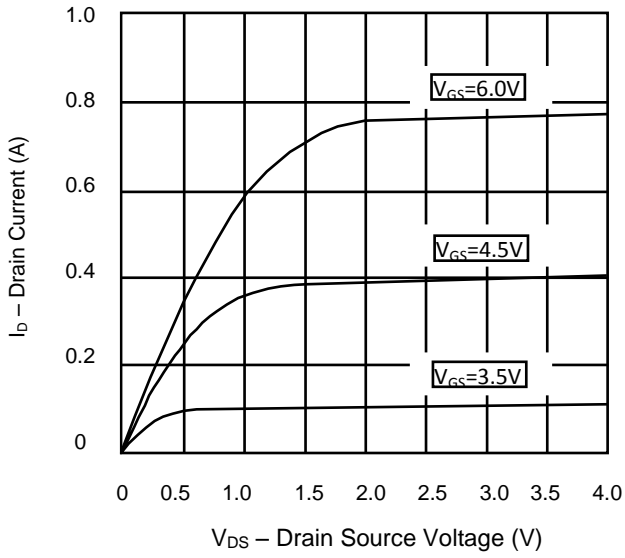
**Electrical Characteristics (  $T_A = 25^\circ\text{C}$  unless otherwise noted )**

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>OFF Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 10\mu A$	60			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 60V, V_{GS} = 0V$			60	nA
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$			$\pm 10$	$\mu A$
Gate threshold voltage <sup>1)</sup>	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.2		1.5	V
Drain-source on-resistance <sup>1)</sup>	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 500mA$		3.5	4.5	$\Omega$
		$V_{GS} = 4.5V, I_D = 50mA$		3.5	4.5	
Diode Forward Voltage	$V_{SD}$			0.72	1	V
Maximum Body-Diode Continuous Current	$I_S$				0.2	A
<b>Dynamic characteristics<sup>1)</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 25V, V_{GS} = 0V, f = 1MHz$			40	$\mu F$
Output Capacitance	$C_{oss}$				20	
Reverse Transfer Capacitance	$C_{rss}$				5	
Total Gate Charge	$Q_g$	$I_D = 0.2A, V_{DS} = 6V, V_{GS} = 4.5V$		0.23		nC
Gate-to-Source Charge	$Q_{gs}$			0.05		
Gate-to-Drain(Miller) Charge	$Q_{gd}$			0.06		
<b>Switching Characteristics<sup>1)</sup></b>						
Turn-on delay time	$t_{d(on)}$	$V_{DS} = 30V, V_{GS} = 10V, R_G = 25\Omega, R_L = 150\Omega, I_D = 0.2A$			20	ns
Turn-off delay time	$t_{d(off)}$				20	
Total Gate Charge	$Q_g$	$I_D = 0.2A, V_{DS} = 6V, V_{GS} = 4.5V$		0.23		nC
Gate-to-Source Charge	$Q_{gs}$			0.05		
Gate-to-Drain(Miller) Charge	$Q_{gd}$			0.06		

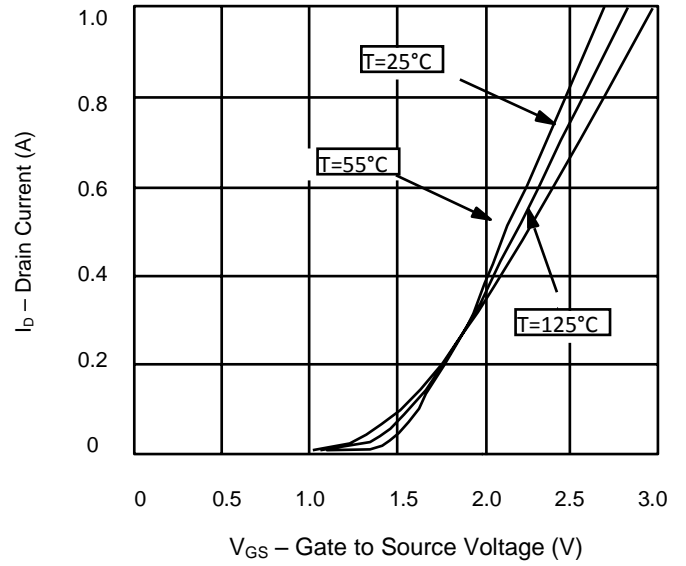
Notes:

1) These parameters have no way to verify.

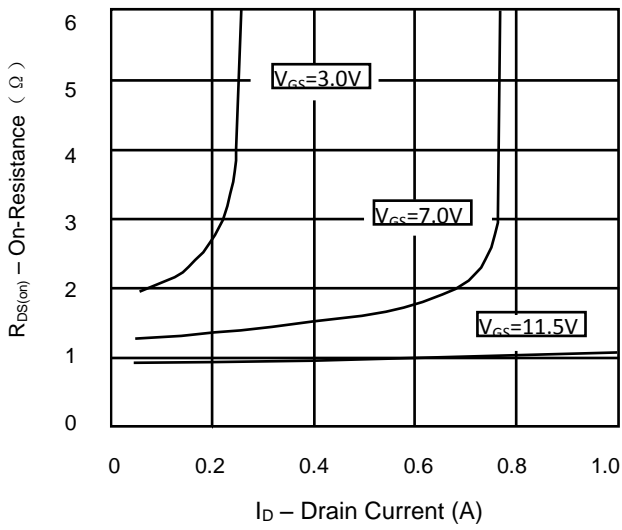
**Typical Characteristics**



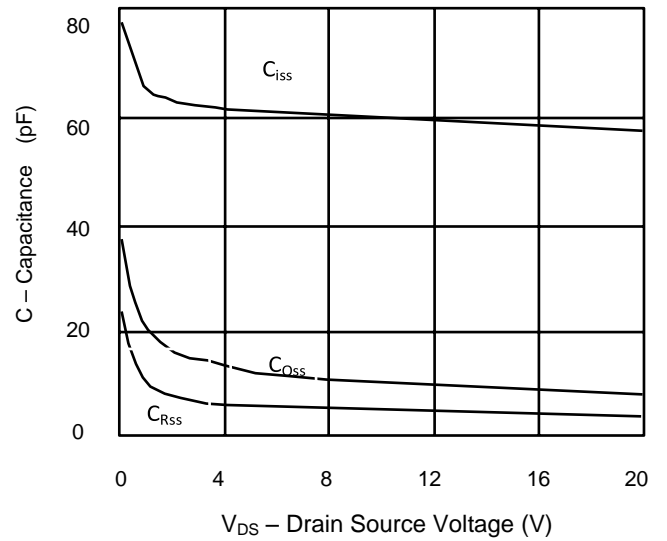
**Fig 1. Output Characteristics**



**Fig 2. Transfer Characteristics**

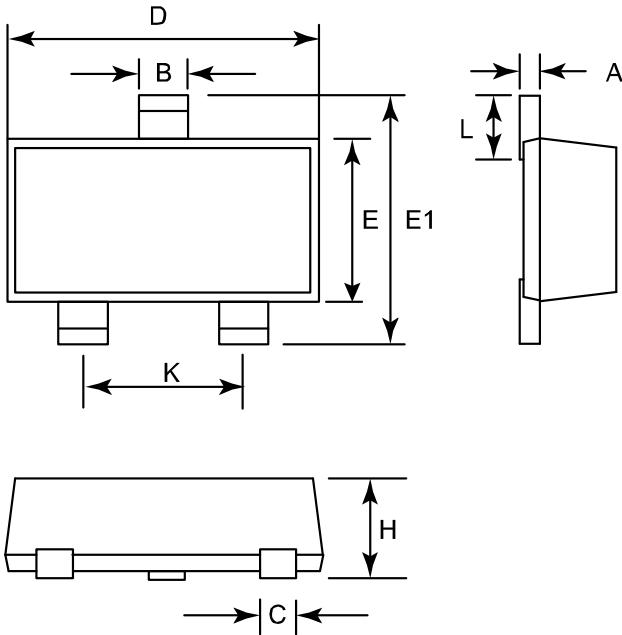


**Fig 3. On-Resistance vs. Drain Current**



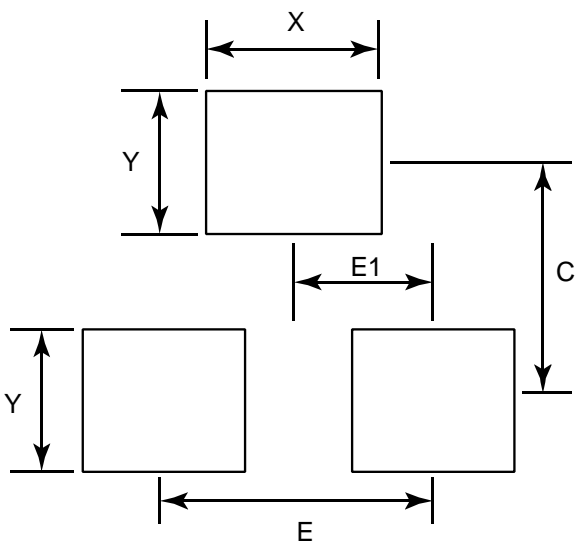
**Fig 4. Capacitance**

**SOT-723 Package Outline Drawing**



SYM	DIMENSIONS		
	MILLIMETERS		
	MIN	NOM	MAX
A	0.08		0.18
B	0.27		0.37
C	0.17		0.27
D	1.15	1.20	1.25
E	0.75	0.80	0.85
E1	1.15	1.20	1.25
K	0.75	0.80	0.85
L	0.25		0.30
H	0.43		0.55

**Suggested Land Pattern**



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
C	1.00	0.04
E	0.80	0.03
E1	0.40	0.016
X	0.65	0.026
Y	0.60	0.024